

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



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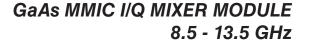






v03.0310





Features

Wide IF Bandwidth: DC - 2 GHz

Image Rejection: 28 dB LO to RF Isolation: 38 dB High Input IP3: +25 dBm Hermetically Sealed Module

Field Replaceable SMA Connectors -55 to +85 °C Operating Temperature

General Description

The HMC-C042 is a passive I/Q MMIC mixer housed in a miniature hermetic module which can be used as either an Image Reject Mixer or a Single Sideband Upconverter. The module utilizes two standard Hittite double balanced mixer cells and a 90 degree hybrid fabricated on a GaAs MESFET process. A low frequency quadrature hybrid was used to produce a 100 MHz USB IF output. This MMIC based module is a more reliable and consistent alternative to hybrid style I/Q Mixers and Single Sideband Converter assemblies. The module features removable SMA connectors which can be detached to allow direct connection of the I/O pins to a microstrip or coplanar circuit.

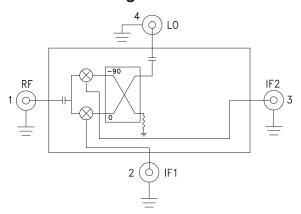


Typical Applications

The HMC-C042 is ideal for:

- Point-to-Point Radios
- Point-to-Multi-Point Radios & VSAT
- Test Equipment & Sensors
- Military End-Use

Functional Diagram



Electrical Specifications, $T_A = +25^{\circ}$ C, IF= 100 MHz, LO = +19 dBm*

Parameter	Min.	Тур.	Max.	Units
Frequency Range, RF/LO	8.5 - 13.5			GHz
Frequency Range, IF		DC - 2		
Conversion Loss (As IRM)		8	10	dB
Image Rejection	17	28		dB
1 dB Compression (Input)		+17		dBm
LO to RF Isolation	35	38		dB
LO to IF Isolation	20	25		dB
IP3 (Input)		+25		dBm
Amplitude Balance		0.6		dB
Phase Balance		6		Deg

^{*} Unless otherwise noted, all measurements performed as downconverter.

HMC-C042* PRODUCT PAGE QUICK LINKS

Last Content Update: 02/23/2017

COMPARABLE PARTS 🖵

View a parametric search of comparable parts.

DOCUMENTATION

Data Sheet

• HMC-C042 Data Sheet

DESIGN RESOURCES 🖵

- HMC-C042 Material Declaration
- PCN-PDN Information
- · Quality And Reliability
- · Symbols and Footprints

DISCUSSIONS

View all HMC-C042 EngineerZone Discussions.

SAMPLE AND BUY 🖳

Visit the product page to see pricing options.

TECHNICAL SUPPORT 🖳

Submit a technical question or find your regional support number.

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8.5 - 13.5 GHz



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Data taken As IRM With External IF Hybrid Conversion Gain vs. Temperature

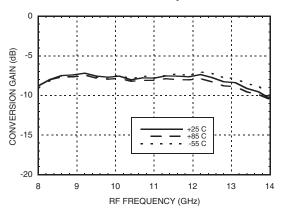
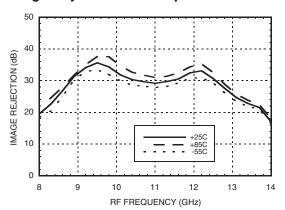
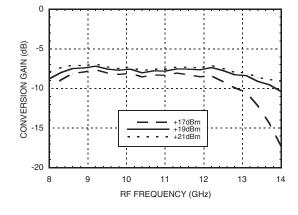


Image Rejection vs. Temperature

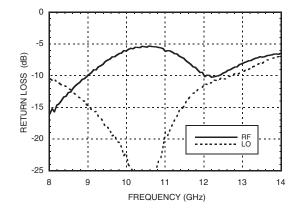


GaAs MMIC I/Q MIXER MODULE

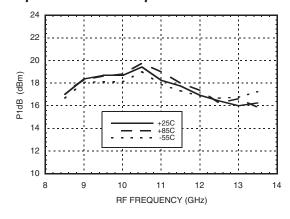
Conversion Gain vs. LO Drive



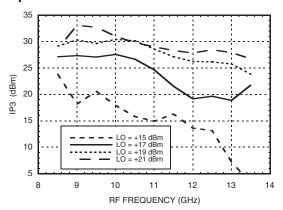
Return Loss



Input P1dB vs. Temperature



Input IP3 vs. LO Drive



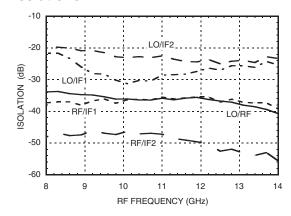




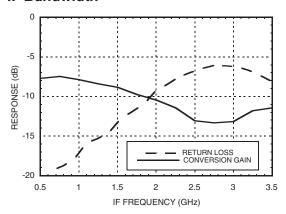
GaAs MMIC I/Q MIXER MODULE 8.5 - 13.5 GHz

Quadrature Channel Data Taken Without IF Hybrid

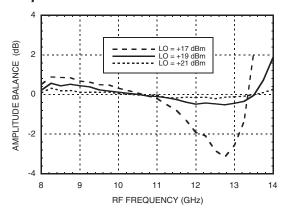
Isolations



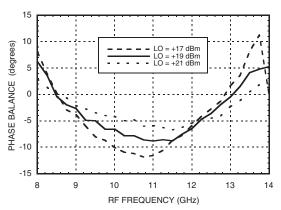
IF Bandwidth*



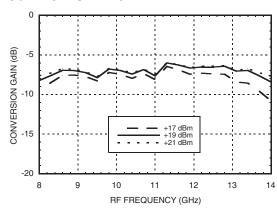
Amplitude Balance vs. LO Drive



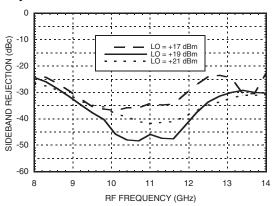
Phase Balance vs. LO Drive



Upconverter Performance Conversion Gain vs. LO Drive*



Upconverter Performance Sideband Rejection vs. LO Drive*



^{*} Conversion gain data taken with external IF hybrid



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GaAs MMIC I/Q MIXER MODULE 8.5 - 13.5 GHz

Harmonics of LO

10 From (CLIE)	nLO Spur at RF Port			
LO Freq. (GHz)	1	2	3	4
8.5	34	48	50	77
9.5	35	47	57	64
10.5	36	51	62	53
11.5	35	57	67	45
12.5	36	52	67	47
13.5	38	51	64	xx

LO = +19 dBm

Values in dBc below input LO level measured at RF Port.

MxN Spurious Outputs

	nLO				
mRF	0	1	2	3	4
0	xx	-11	16	22	38
1	33	0	53	62	95
2	86	77	76	78	94
3	96	95	101	91	102
4	89	94	96	101	107

RF = 10.6 GHz @ -10 dBm LO = 10.5 GHz @ +19 dBm

Data taken without IF hybrid

All values in dBc below IF power level



ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

Absolute Maximum Ratings

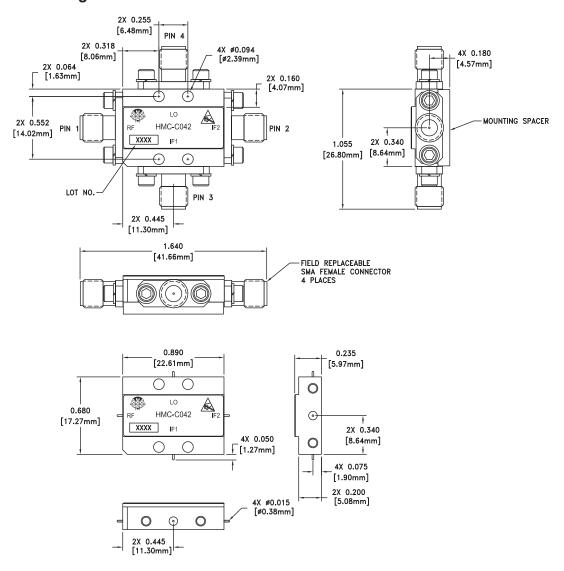
RF / IF Input	+20 dBm
LO Drive	+27 dBm
Channel Temperature	150°C
Continuous Pdiss (T=85°C) (derate 7.1 mW/°C above 85°C)	460 mW
Thermal Resistance (R _{TH}) (junction to die bottom)	140 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-55 to +85 °C





GaAs MMIC I/Q MIXER MODULE 8.5 - 13.5 GHz

Outline Drawing



VIEW SHOWN WITH CONNECTORS REMOVED

NOTES:

- 1. PACKAGE, LEADS, COVER MATERIAL: KOVAR™
- 2. FINISH: GOLD PLATE OVER NICKEL PLATE
- 3. MOUNTING SPACER: NICKEL PLATED ALUMINUM
- 4. ALL DIMENSIONS ARE IN INCHES [MILLIMETERS]
- 5. TOLERANCES:
 - $5.1 .XX = \pm 0.02$
- $5.2.XXX = \pm 0.010$
- 6. FIELD REPLACEABLE SMA CONNECTORS
 TENSOLITE 5602 5CCSF OR EQUIVALENT
- 7. TO MOUNT MODULE TO SYSTEM PLATFORM REPLACE 0 -80 HARDWARE WITH DESIRED MOUNTING SCREWS

Package Information

Package Type	C-4
Package Weight [1]	20 gms [2]
Spacer Weight	2.6 gms [2]

[1] Includes the connectors

[2] ±1 gms Tolerance



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GaAs MMIC I/Q MIXER MODULE 8.5 - 13.5 GHz

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1	RF	This pin is AC coupled and matched to 50 Ohms.	RF 0
2	IF1	This pin is DC coupled. For applications not requiring operation to DC, this port should be DC blocked externally using a series capacitor whose value has	IF1,IF2 O
3	IF2	been chosen to pass the necessary IF frequency range. For operation to DC, this pin must not source/ sink more than 3 mA of current or part non-function and possible part failure will result.	
4	LO	This pin is AC coupled and matched to 50 Ohms.	LO ○──